

AN-EVAL 2x8-ISO11811T

ISOFACE™ Evaluation Board for galvanically isolated 8-Channel Digital Input ICs with IEC61131-2 compatible characteristics for industrial applications

ISO11811T EVAL - Board

Application Note

V 1.2, 2011-09-09

Edition 2011-09-09

**Published by
Infineon Technologies AG
81726 Munich, Germany**

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Revision History

| Page or Item | Subjects (major changes since previous revision) |
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| V 1.2, 2011-09-09 | Updated version |
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Table of Contents

| | | |
|----------|-------------------------------------|----|
| | Table of Contents | 4 |
| 1 | Introduction | 6 |
| 2 | Board Characteristics | 7 |
| 3 | Functional Description | 8 |
| 3.1 | Power Supply | 9 |
| 3.2 | Oscillator | 9 |
| 3.3 | Parallel Interface | 9 |
| 3.3.1 | μ C Control Mode | 9 |
| 3.3.2 | Direct Control Mode | 11 |
| 3.4 | Serial Interface | 12 |
| 3.5 | Sensor Input Stage | 13 |
| 3.6 | Filter Setting | 14 |
| 4 | Connectors | 15 |
| 5 | Schematic | 17 |
| 6 | PCB Layout | 19 |
| 7 | Bill of Material | 20 |



Draft Version

1 Introduction

Application

This Application Note describes an Evaluation Board with two isolated 8 Channel IEC61131-2 compatible Digital Input IC's for a wide range of industrial applications.

The board is designed to allow easy exploration of the features of the ISOFACE™ Digital Input part. It contains two ISO1811T as an electrically isolated 8 bit data input interface in TSSOP-48 package. These parts are used to detect the signal states of up to eight independent input lines according to IEC61131-2 Type 1/2/3 (e.g. two-wire proximity switches) with a common ground.

An 8 bit parallel/serial µC compatible interface allows to connect the IC directly to a µC system. The input interface supports also a direct control mode and is designed to operate with 3.3/5V CMOS compatible levels.

The data transfer from input to output side across the galvanic isolation uses Infineon's Coreless Transformer Technology.

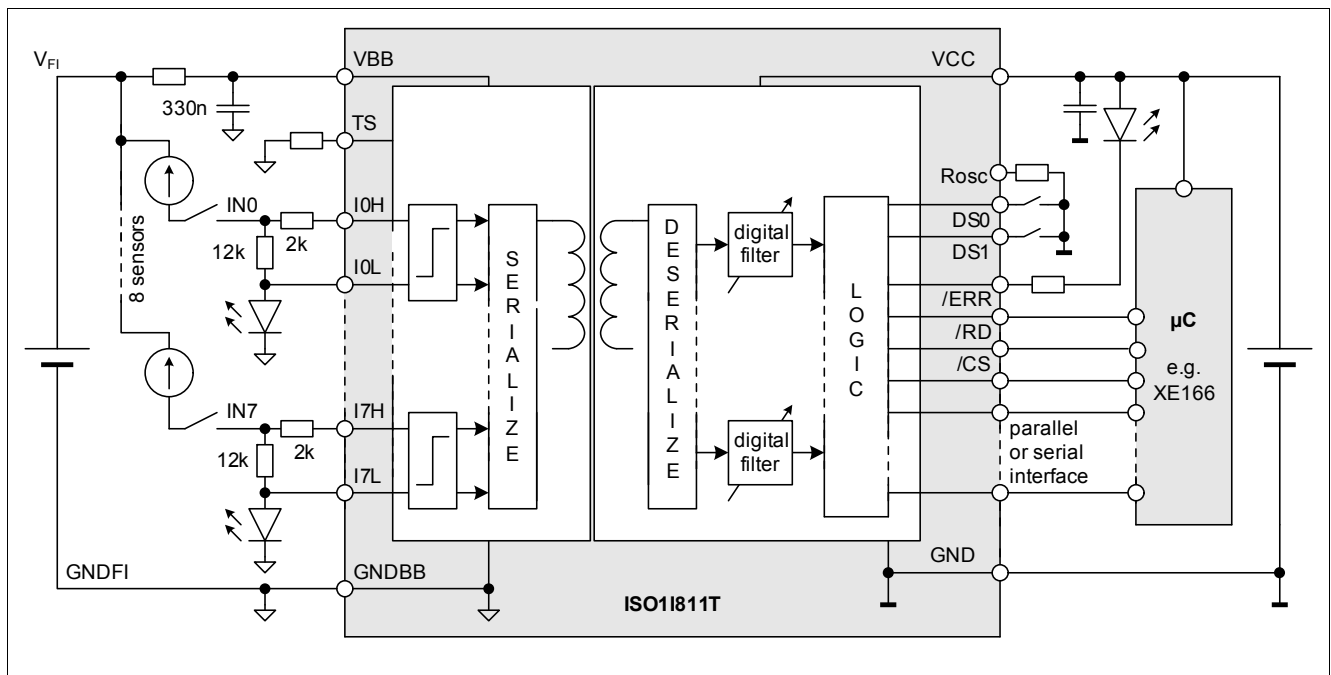


Figure 1 Typical Application

ISO1I811T

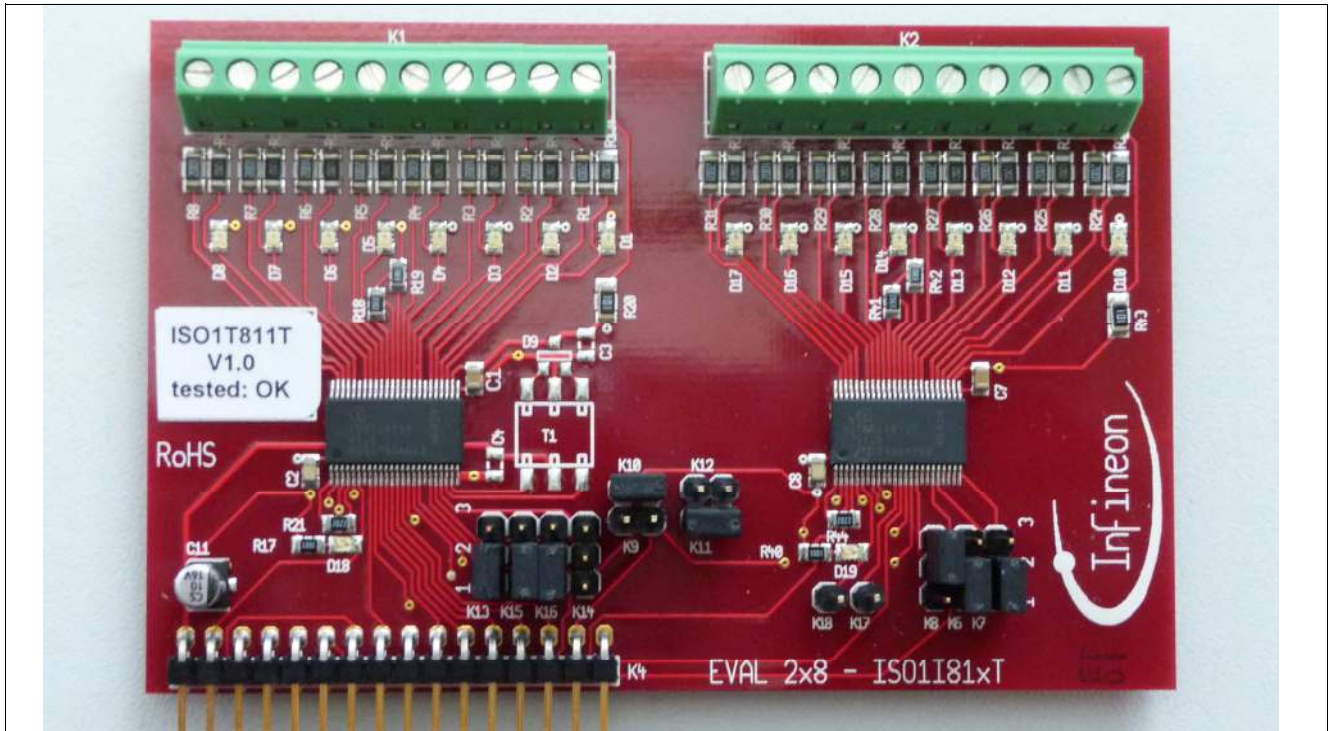


Figure 2 EVAL 2x8-ISO1I811T

2 Board Characteristics

Table 1 Board Characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|----------------------------|-----------|---------------------|------|--------------------------|------|-----------------------------------|
| | | Min. | Typ. | Max. | | |
| V_{BB} Input Voltage | V_{BB} | 9.6 | – | 35 | V | |
| VINx Input Voltage | V_{INx} | -35 | | 35 | V | |
| V_{CC} Input Voltage | V_{CC} | 3.0 | – | 5.5 | V | |
| Logic Signals uC Interface | V_{IL} | -0.3 | – | $0.3 \times V_{CC}$ | V | |
| | V_{IH} | $0.7 \times V_{CC}$ | – | $V_{CC} + 0.3 \text{ V}$ | V | |
| Oscillator Frequency | | 50 | | 125 | kHz | set to 125kHz using R_{OSC} 82k |

For a complete description of the characteristics of the ISO1I811T please consult respective Data Sheet available at: www.infineon.com/isoface

Note: this board is intended to be used in the lab to explore the functionality of the ISO1I811T device. It is not designed to be used in professional applications!

3 Functional Description

This board contains two ISO11811T as an electrically isolated 8 bit data input interface in TSSOP-48 package. These parts are used to detect the signal states of up to eight independent input lines according to IEC61131-2 Type 1/2/3 (e.g. two-wire proximity switches) with a common ground.

For operation in accordance with IEC61131-2, it is necessary for the ISO11811T to be wired with resistors rated R_{IN} and R_{LED} . (it is recommended to use resistors with an accuracy of 2%, in any case < 5% - mandatory, temperature-coefficients < 200ppm are allowed)

A parallel/serial μC compatible interface allows to connect the board directly to a μC system.

If the parallel interface is used, only IC1 can be operated. In serial mode either IC1 can be used with 8 Bit SPI or IC1 and IC2 can be put into a Daisy Chain configuration with 16 Bit SPI.

The isolated data transfer from input to output side is realized by the integrated Coreless Transformer Technology.

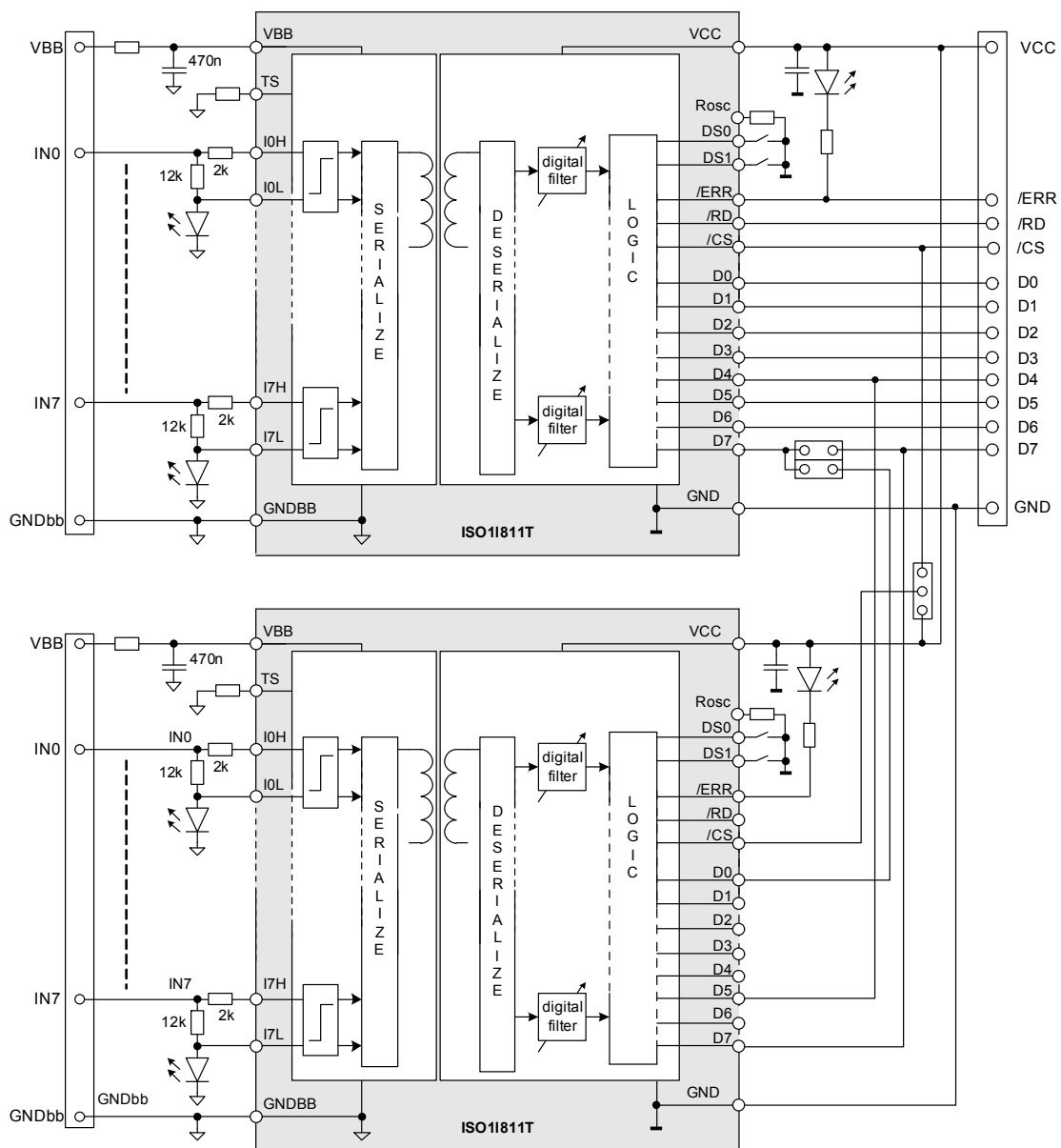


Figure 3 Block Diagram

3.1 Power Supply

The IC contains 2 electrically isolated voltage domains that are independent from each other. The microcontroller interface is supplied via pin VCC and the input stage is supplied via pin VBB. The different voltage domains can be switched on at different time. If the VCC and VBB voltage have reached their operating range and the internal data transmission have been started successfully, the IC indicates the end of the Start-Up procedure by setting the pin /ERR to logic high.

3.2 Oscillator

The frequency of the internal oscillator can be set by the resistor R_{OSC} . This internal oscillator provides the clock for the data sampling and transmission as well as for the digital averaging filter. For adjusting the frequency of the oscillator the values of R_{OSC} can be taken out of the diagram in the ISO1I811T datasheet.

3.3 Parallel Interface

The ISO1I811T contains a parallel interface that can be selected by pulling the pin SEL to logic low state (see also [Table 2](#)).

This interface can be directly controlled by the microcontroller output signals. The parallel interface can also be switched over to a direct control that allows direct changes of the inputs IN0...IN7 by means of the corresponding inputs D0 ... D7 on the Demo Board without additional logic signals. To activate the parallel direct control mode, both the pin \overline{CS} and pin \overline{RD} must be connected to ground.

Table 2 Mode Select

| Mode | K13 | K9 | K10 | K8 | K15 | K16 |
|--------------------|-------|-------|-------|-------|---------|---------|
| Parallel (IC1) | 2 - 3 | close | open | 1 - 2 | open | open |
| Serial 8 Bit (IC1) | 1 - 2 | close | open | 1 - 2 | Table 4 | Table 4 |
| Serial 16 Bit | 1 - 2 | open | close | 2 - 3 | Table 4 | Table 4 |

3.3.1 μ C Control Mode

\overline{CS} - Chip select. The system microcontroller selects the ISO1I811T by means of the pin \overline{CS} . Whenever the pin is in a logic low state, data can be transferred from the μ C.

\overline{RD} - Read. The system controller enables the read procedure in the ISO1I811T by means of the signal \overline{RD} . A logic low state signal at pin \overline{RD} enables the output data when the pin \overline{CS} is in a logic low state.

D0...D7. The parallel output data is transferred to the data bus a high-to-low transition of the signal \overline{RD} (read) while the \overline{CS} is logic low. Then a low-to-high transition of \overline{CS} sets the driver to tristate.

The μ C Control Mode can be operated by connecting a Processor Board to the corresponding Signals of Connector K4. The timing requirements for the μ C Control Mode are shown in [Figure 5](#).

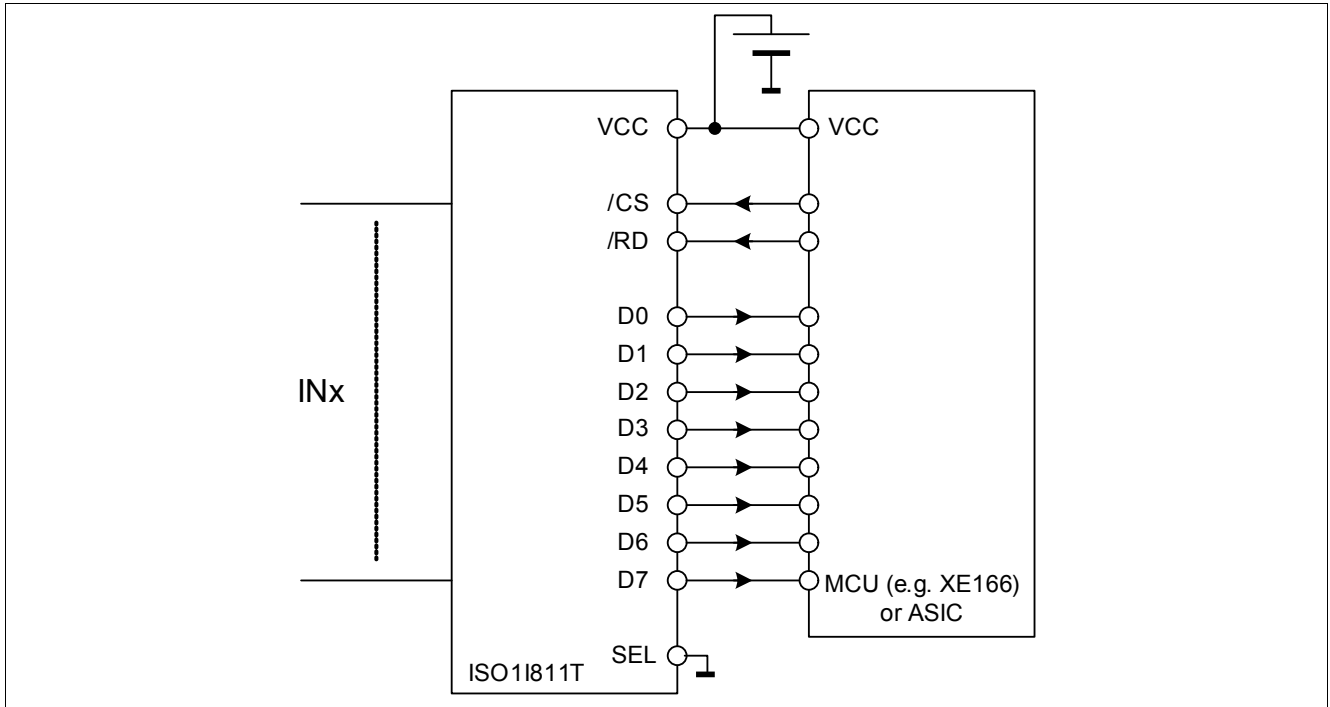


Figure 4 μC Control Mode

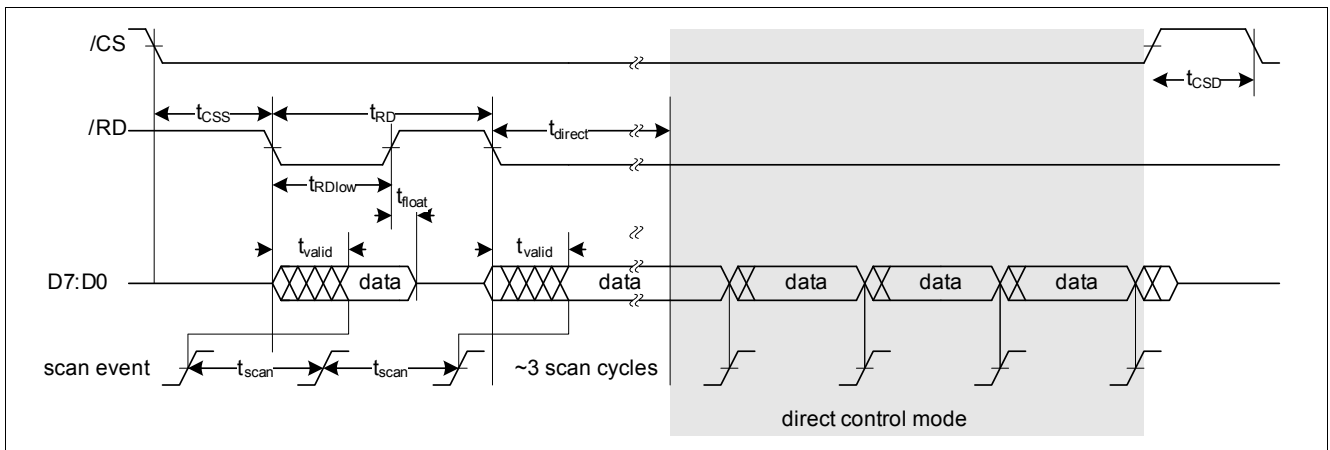


Figure 5 Timing Diagram μC Control Mode

3.3.2 Direct Control Mode

Beside the use of the parallel μ C compatible interface, a parallel direct control mode can be chosen. In this mode, the output Data D0...D7 will directly follow the inputs IN0...IN7 without the need for additional logic signals. To activate this mode, pin \overline{CS} and \overline{RD} must be connected to ground for a time longer than 15 μ s (see also [Figure 6](#)).

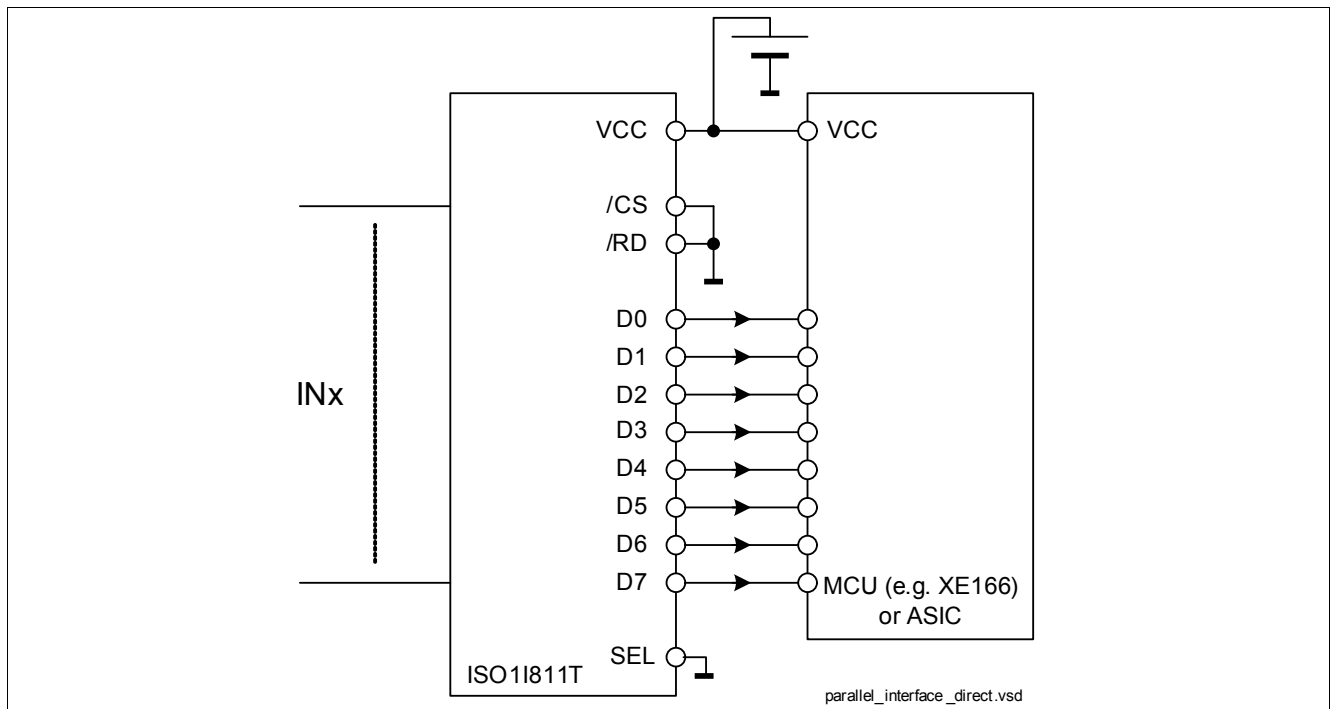


Figure 6 Direct Control Mode

3.4 Serial Interface

The ISO11811T contains a serial interface that can be activated by pulling the pin SEL to logic High state. It can be directly controlled by the microcontroller output ports. The output pin SDO is in state "Z" as long as $\overline{CS}=1$. Otherwise, the bits are sampled with the falling edge of \overline{CS} . With every falling edge of SCLK the bits are provided serially to the pin SDO, respectively. At the same time, the input to SDI is put into an 8bit FIFO buffer sampled with the rising edge of SCLK. When all 8 internally sampled bits from SDI input have been put to SDO, the buffered bits are provided to these pins (Daisy Chain Mode). The timing requirements for the serial interface are shown in [Figure 8](#).

The serial interface can be set to 8 Bit operation by using IC1 only or to 16 Bit operation by using IC1 and IC2 in Daisy Chain Mode. For this purpose the jumpers K8, K9, K10 have to be set in the according manner (see also [Figure 7](#), [Table 2](#))

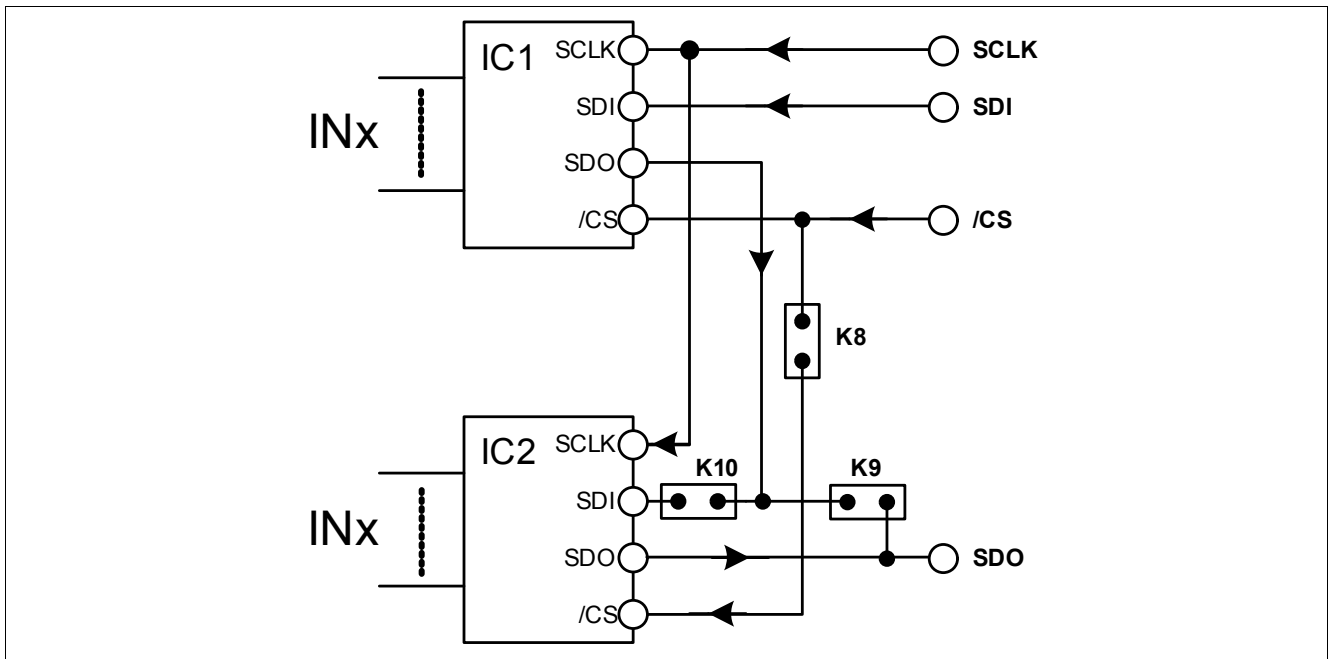


Figure 7 SPI Configuration

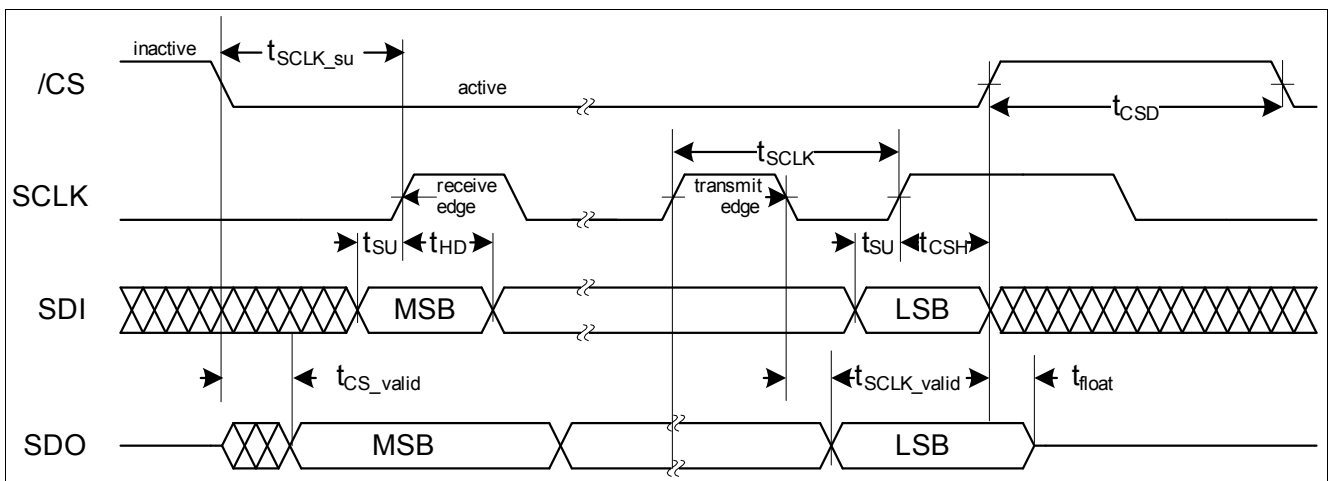


Figure 8 Timing Diagram Serial Mode

3.5 Sensor Input Stage

The sensor input structure is shown in **Figure 9**. Due to its active current a I-V-characteristic as shown in **Figure 10** is maintained. This I-V-curve is well within the IEC 61131 standard requirements of Type 1 and Type 3 sensors, respectively. Type 2 sensors are supported as well with the restriction that 2 input channels have to be used in parallel i.e. only 4 channels are available. Additionally R_{IN} and R_{LED} has to be modified according **Figure 9**. It is recommended to choose for the external resistors R_{IN} , R_{LED} an accuracy of 2 % (< 5% is mandatory) otherwise the I/V-characteristic shown in **Figure 10** cannot be attained. The Input Type 1, 2, 3 can be selected by modifying R_{TS} according **Table 3**.

Table 3 Type Select

| Input Characteristic according IEC61131-2 | Type 1 | Type 2 | Type 3 |
|---|--------|--------|--------|
| R_{TS} | 33R | 33k | 330k |

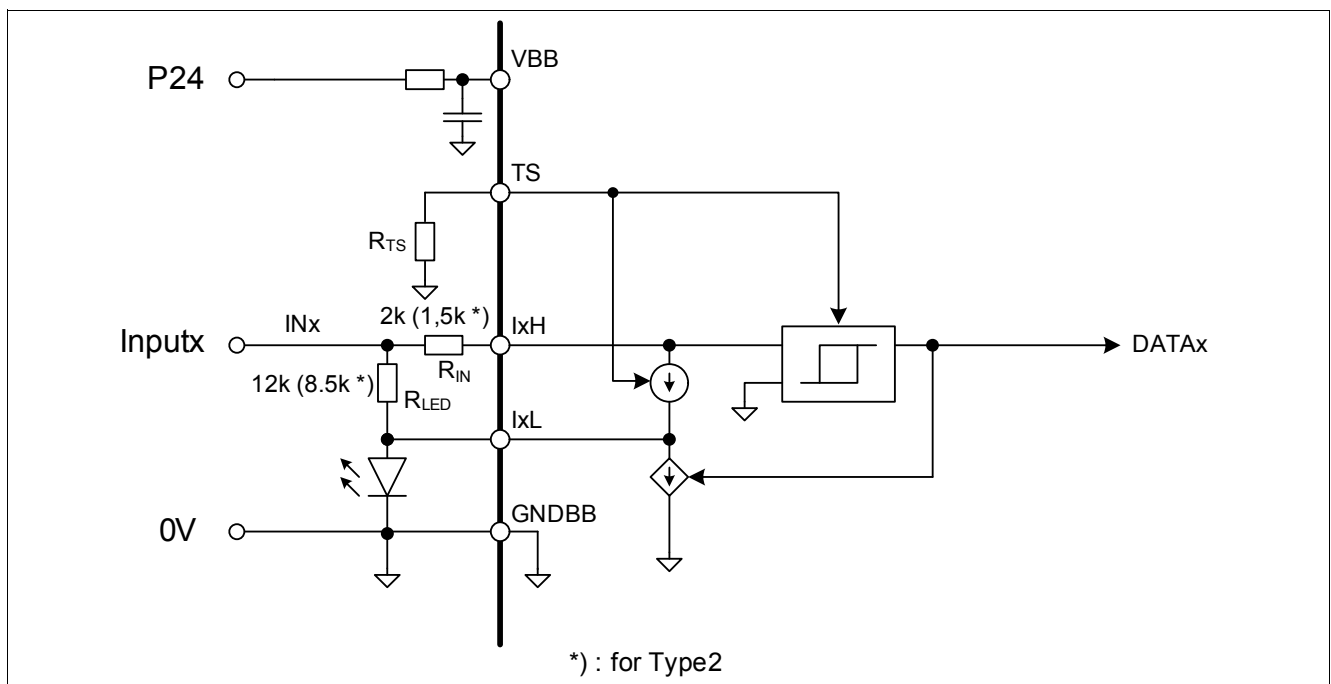


Figure 9 Sensor Input

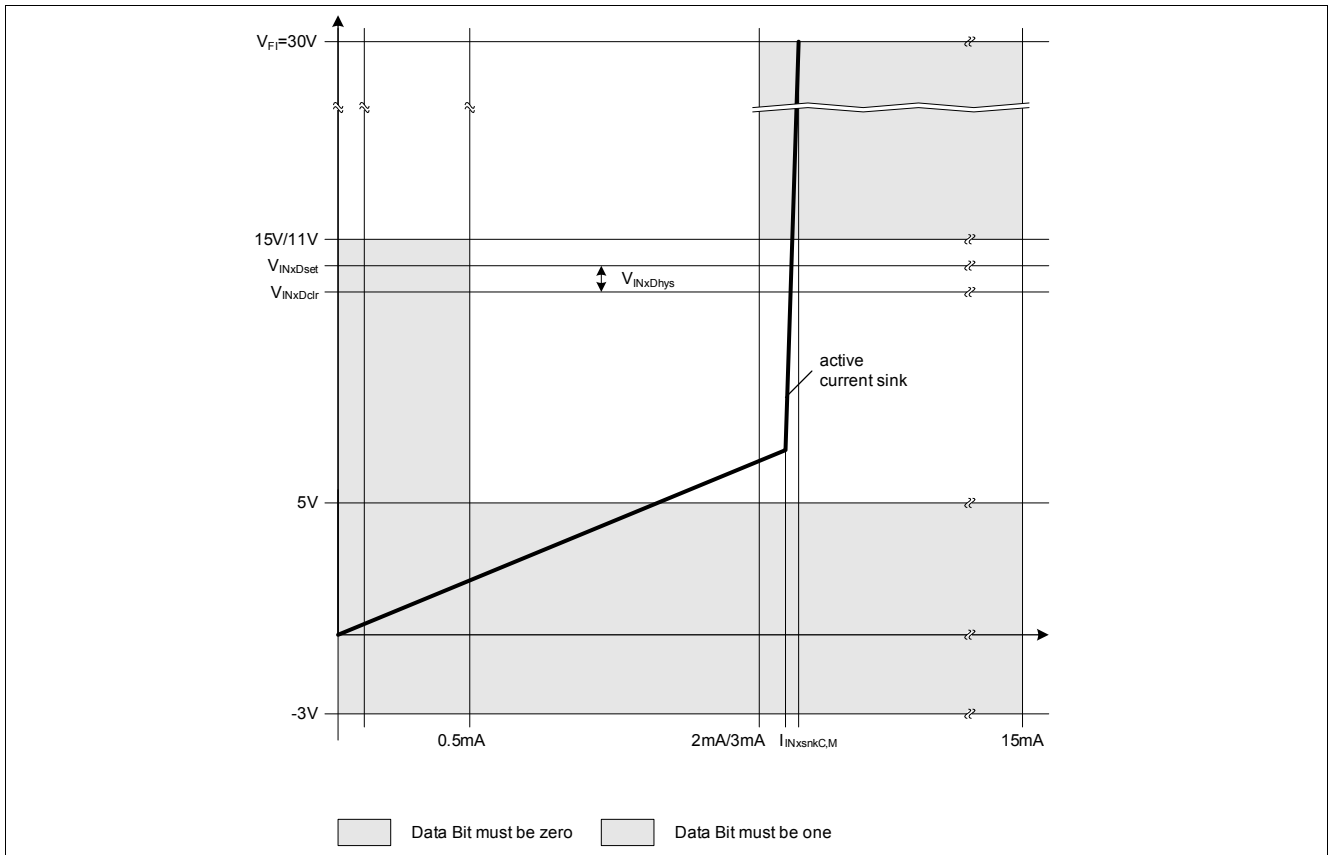


Figure 10 Sensor Input Characteristic

3.6 Filter Setting

The sensor data bits can be filtered by a configurable digital input filter. If selected, the filter changes its output according to an averaging rule with a selectable average length. When the sensor state changes without any spikes and noise the change is delayed by the averaging length. Sensor spikes that are shorter than the averaging length are suppressed. The averaging length is selected using the configuration pins DS0 and DS1. See [Table 4](#) for the different setting options including filter bypass. The filters are dimensioned for the nominal internal sampling fscannom. The corresponding filter delays can be adjusted by changing the oscillator frequency i.e. by tuning the resistor at the pin R_{OSC}.

Table 4 Filter Time Setting

| | K15 | K16 | K6 | K7 |
|--------------|-------|-------|-------|-------|
| Delay Time | IC1 | | IC2 | |
| 0ms (bypass) | 1 - 2 | 1 - 2 | 1 - 2 | 1 - 2 |
| 1ms | 2 - 3 | 1 - 2 | 2 - 3 | 1 - 2 |
| 3.2ms | 1 - 2 | 2 - 3 | 1 - 2 | 2 - 3 |
| 10ms | 2 - 3 | 2 - 3 | 2 - 3 | 2 - 3 |

4 Connectors

Table 5 K1, K2 Connector

| Pin Number | K1 (IC1) | K3 (IC2) |
|------------|------------|------------|
| 1 | V_{BB} | V_{BB} |
| 2 | Input0 | Input0 |
| 3 | Input1 | Input1 |
| 4 | Input2 | Input2 |
| 5 | Input3 | Input3 |
| 6 | Input4 | Input4 |
| 7 | Input5 | Input5 |
| 8 | Input6 | Input6 |
| 9 | Input7 | Input7 |
| 10 | GND_{BB} | GND_{BB} |

Table 6 K4 Connector

| Pin Number | Serial Mode | Parallel Mode |
|------------|------------------|------------------|
| 1 | VCC | VCC |
| 2 | \overline{ERR} | \overline{ERR} |
| 3 | | NC |
| 4 | | \overline{RD} |
| 5 | DS0 | DS0 |
| 6 | DS1 | DS1 |
| 7 | \overline{CS} | \overline{CS} |
| 8 | SDI | D0 |
| 9 | | D1 |
| 10 | | D2 |
| 11 | | D3 |
| 12 | | D4 |
| 13 | SCLK | D5 |
| 14 | | D6 |
| 15 | SDO | D7 |
| 16 | | GND |

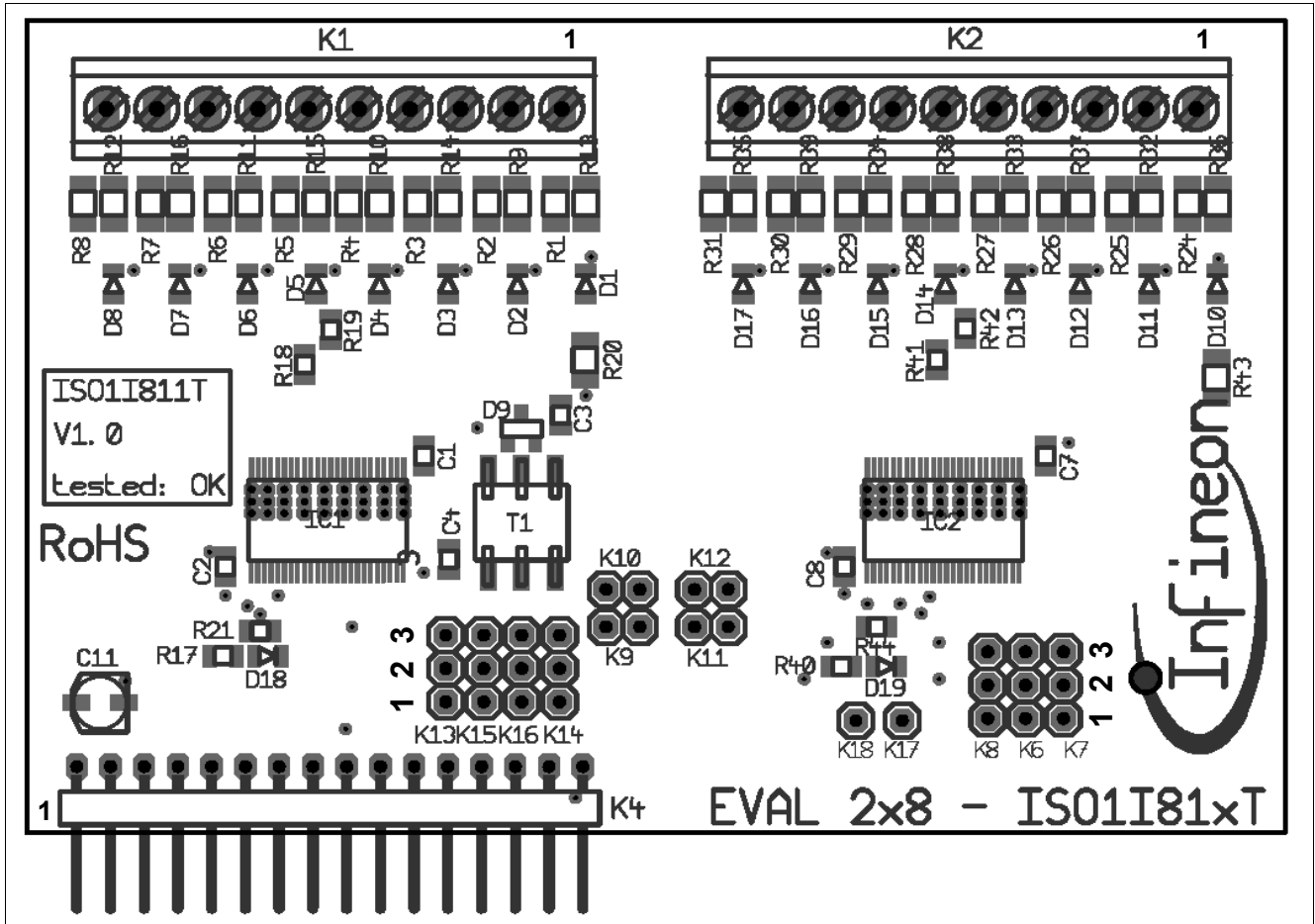


Figure 11 Board Assembly

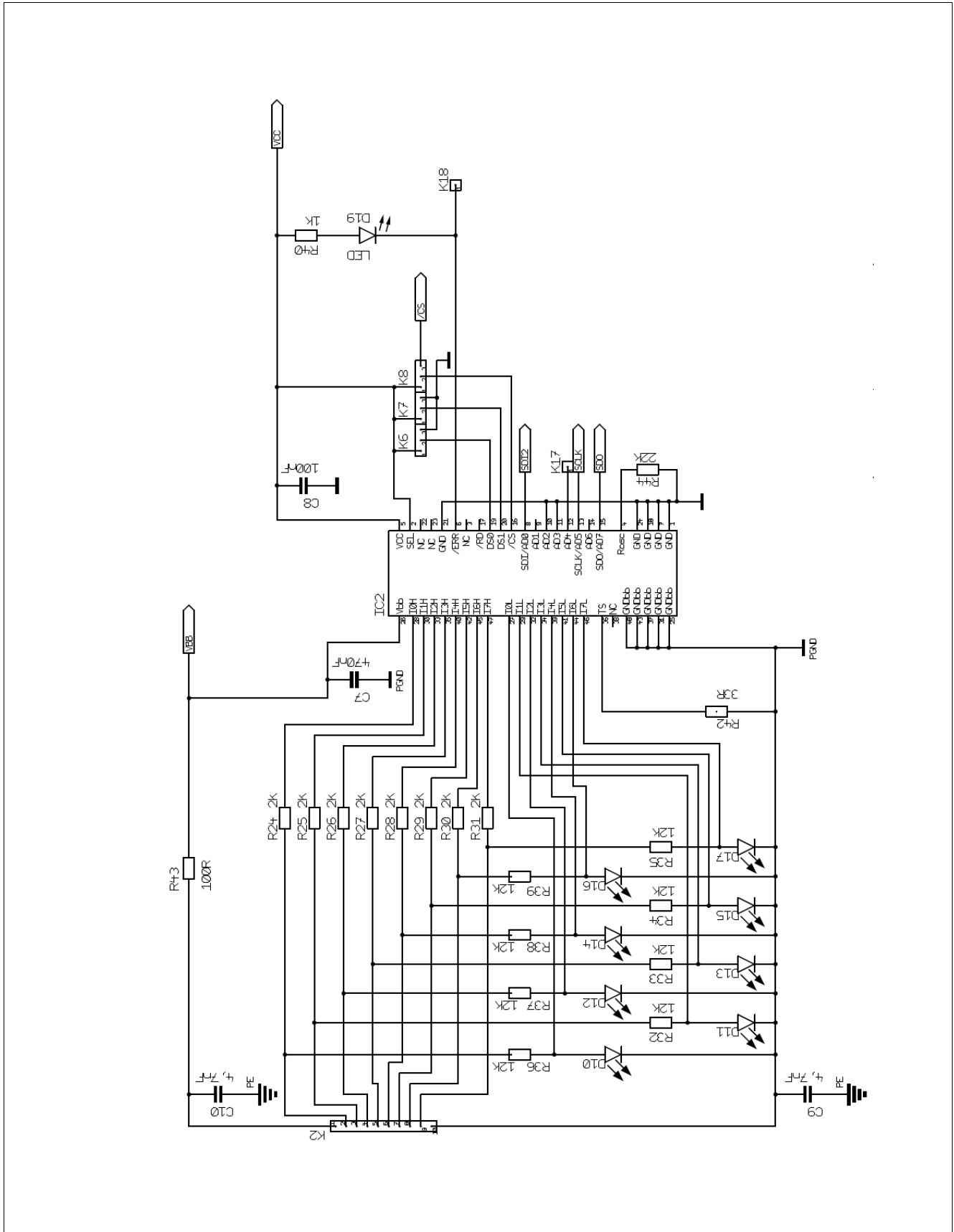


Figure 13 Schematic Page 2

6 PCB Layout

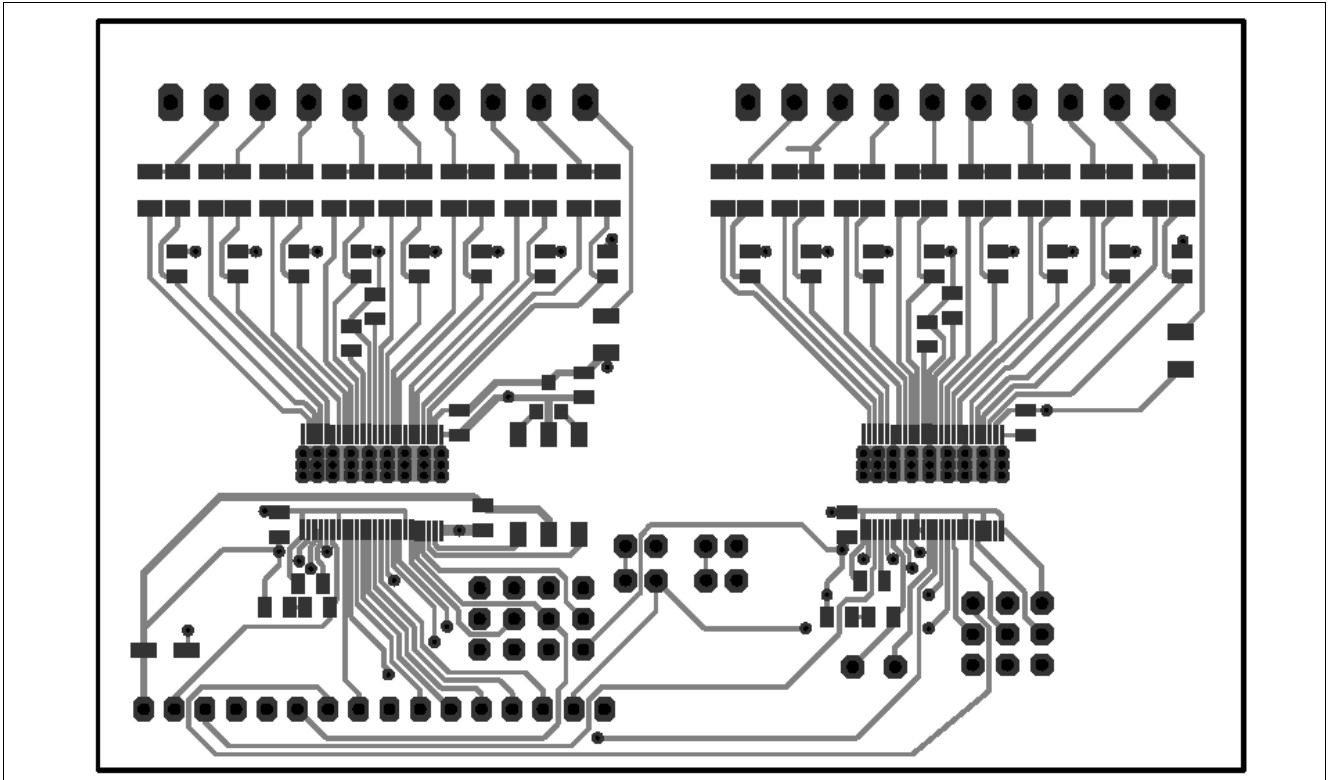


Figure 14 Board Layout - Component Side

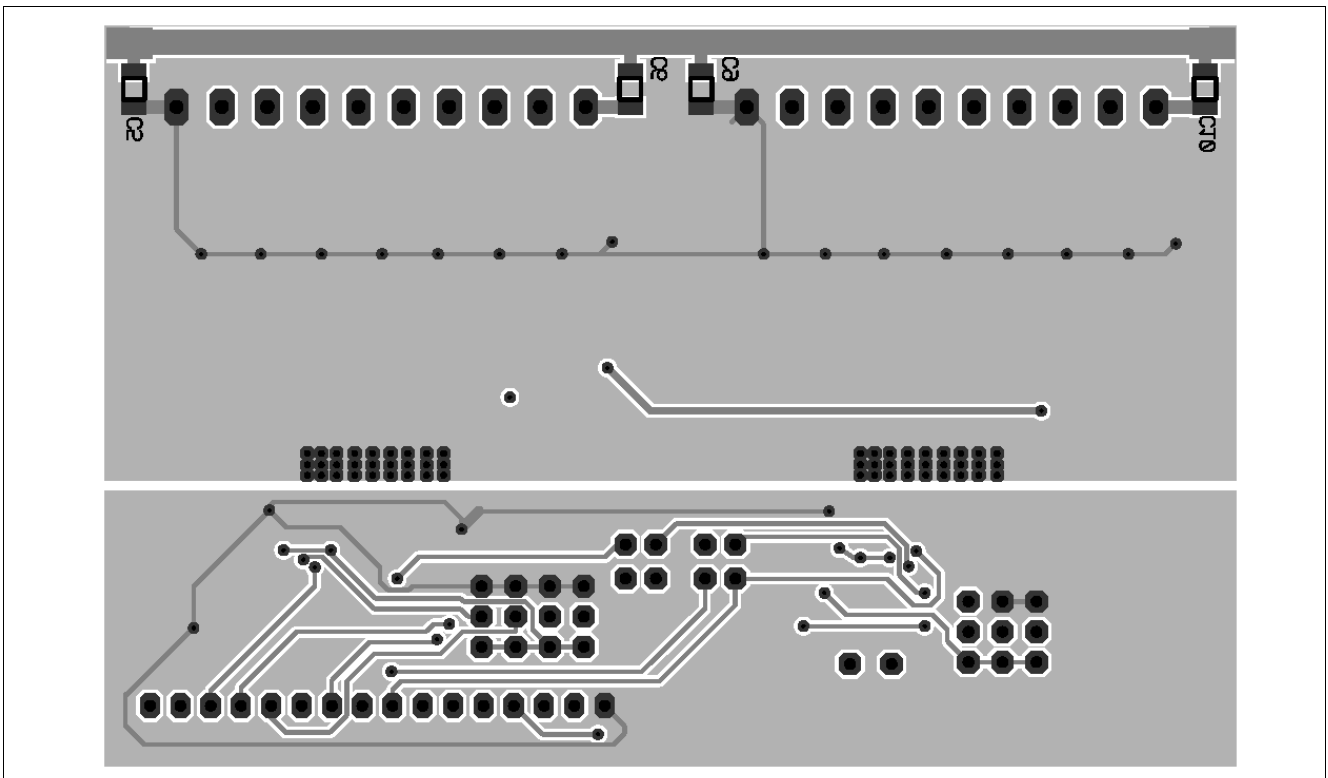


Figure 15 Board Layout - Bottom Side (mirror view)

7 Bill of Material

Table 7 Bill of Material

| Nr | Quant. | Pos. | Value | Package |
|----|--------|---|------------------------|------------|
| 1 | 2 | C1, C7 | 470nF, 50V | 805 |
| 2 | 1 | C11 | 10uF, 16V | SMD-B |
| 3 | 2 | C2, C8 | 100nF, 50V | 805 |
| 4 | 16 | D1, D2, D3, D4, D5, D6, D7, D8, D10, D11, D12, D13, D14, D15, D16, D17 | LED, gn KPHCM-2012CGCK | 0805-DIODE |
| 5 | 2 | D18, D19 | LED, rt KPHCM-2012EC-T | 0805-DIODE |
| 6 | 2 | IC1, IC2 | ISO11811T | TSSOP48 |
| 7 | 2 | K1, K2 | MKDS 1/10-3,81 | 10x3,81mm |
| 8 | 2 | K9, K10 | Connector 2pol | 2,54mm |
| 9 | 6 | K6, K7, K8, K13, K15, K16 | Connector 3pol | 2,54mm |
| 10 | 2 | K17, K18 | Connector 1pol | 2,54mm |
| 11 | 1 | K4 | Connector 16pol | 2,54mm |
| 12 | 16 | R1, R2, R3, R4, R5, R6, R7, R8, R24, R25, R26, R27, R28, R29, R30, R31 | 2k, 1% | 1206 |
| 13 | 2 | R17, R40 | 1k, 1% | 805 |
| 14 | 2 | R19, R42 | 33R, 1% | 805 |
| 15 | 2 | R20, R43 | 100R, 1% | 1206 |
| 16 | 2 | R21, R44 | 82k, 1% | 805 |
| 17 | 16 | R9, R10, R11, R12, R13, R14, R15, R16, R32, R33, R34, R35, R36, R37, R38, R39 | 12k, 1% | 1206 |
| 18 | 5 | | Spacer D8mm , H2,8mm | |
| 19 | 1 | wire | K11 | 2,54mm |
| 20 | 6 | Jumper | | |
| 21 | 1 | | Print Board | |

References

- [1] ISO1I811T, Isolated 8 Channel Digital Input with IEC61131-2 Type 1/2/3 Characteristics, Data Sheet, Infineon Technologies

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